WIMA MP 3R-Y2

Metallized Paper (MP) RFI-Capacitors
Class Y2 with Internal Series Connection
PCM 15 mm to 27.5 mm

Special Features

- **Particularly high reliability against active and passive flammability**
- **Twice the safety by internal series connection**
- **High degree of interference suppression due to good attenuation and low ESR**
- **For temperatures up to +110° C**
- **According to RoHS 2002/95/EC**

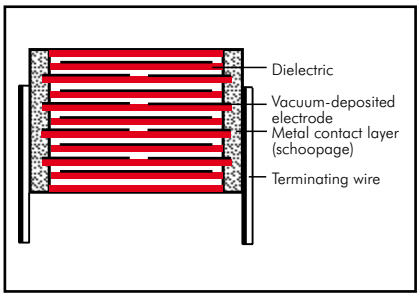
Typical Applications

Class Y2 RFI applications to meet EMC regulations

- **Capacitors connected to the mains between phase or neutral and earthed casing**
- **By-passing of the basic or supplementary insulation, pulse peak voltage ⩽ 5 kV**

Construction

Dielectric:
Paper, epoxy resin impregnated
Capacitor electrodes:
Vacuum-deposited
Internal construction:



Encapsulation:
Self-extinguishing epoxy resin, UL 94 V-0.
metal foil
Terminations:
Tinned wire.
Marking:
Marking: Black on Silver.
For a transition period the capacitors will still be marked „WIMA MP 30-Y2".

Electrical Data

Capacitance range:
1000 pF to 0.1 µF (E12-values on request)
Rated voltage:
250 VAC
Continuous DC voltage* (general guide):
⩽ 1250 V
Capacitance tolerances:
±20%
Operating temperature range:
–40° C to +110° C
Climatic test category:
40/110/56/C in accordance with IEC
Insulation resistance at +20° C:
⩾ 12 x 10^3 MΩ
Measuring voltage: 100 V/1 min.
Dissipation factors:
tan δ ⩽ 13 x 10^{-3} at 1 kHz and +20° C
Test specifications:
In accordance with DIN EN 60384-14
Approvals:

Country	Authority	Specification	Symbol	Approval-No.
Germany	VDE	DIN EN 132400 IEC 60384-14/2	EN 132400	91851
USA	UL	UL 1414 (250 VAC)		E 134915
Canada	CSA	C 22.2 No. 1		LR 93312-1

Maximum pulse rise time:

Capacitance pF/µF	Pulse rise time V/µsec max. operation
1000 ... 2200	2000
3300 ... 0.015	1500
0.022 ... 0.1	500

for pulses equal to a voltage amplitude with $\sqrt{2}$ x 250 VAC = 355 V
according to IEC 60384-14
Test voltage: 3000 VDC, 2 sec.
Reliability:
Operational life > 300000 hours
Failure rate < 1 fit (0.5 x U_r and 40° C)

Mounting Recommendation

To minimize or avoid shock and/or vibration stresses to terminating wires and solder connections we recommend to fix voluminous resin-potted MP capacitors as from e.g. PCM 22.5 mm in an appropriate way since for constructional reasons they do not sit tight on the board.

* If safety-approved EMI suppression capacitors are operated with a DC voltage being above the specified AC voltage rating the given approvals are no longer valid (DIN EN 60384-14).

Furthermore the permissible pulse rise time du/dt ($F_{max.}$) will be subject to a reduction according to

$F_{max.} = F_r \times \sqrt{2} \times UAC / UDC$

if the DC operating voltage UDC is higher than $\sqrt{2}$ x UAC

Packing

Available taped and reeled up to and including PCM 22.5 mm.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

WIMA MP 3R-Y2

Continuation

General Data

Capacitance	250 VAC*			
	W	H	L	PCM**
1000 pF	5	13	19	15
1500 „	5	13	19	15
2200 „	5	13	19	15
3300 „	5	13	19	15
4700 „	6	14	19	15
6800 „	7	15	19	15
0.01 µF	8	17	19	15
0.015 „	10	18	19	15
0.022 „	8	20	28	22.5
0.033 „	8	20	28	22.5
0.047 „	10	22	28	22.5
0.068 „	12	24	28	22.5
0.1 µF	13	25	33	27.5

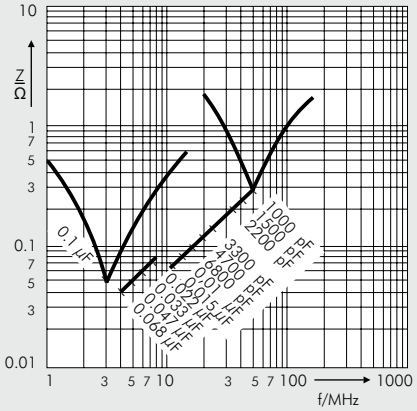
* f = 50/60 Hz

** PCM = Printed circuit module = lead spacing

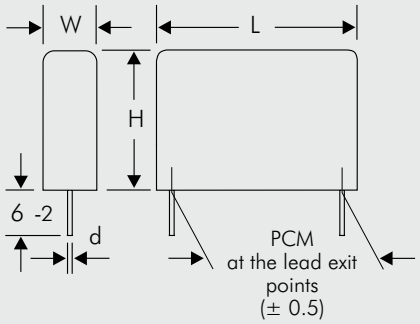
Upon request with long leads 35-2 mm max.

Dims. in mm.

Taped version see page 121.



Impedance change with frequency (general guide)



d = 0.8 ø

Recommendation for Processing and Application of Through-Hole Capacitors

Soldering Process

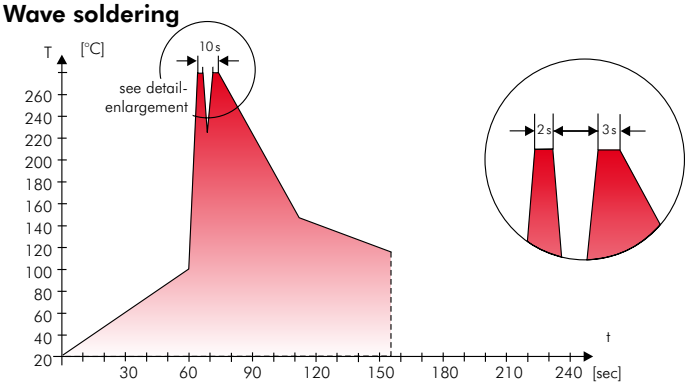
A preheating of through-hole WIMA capacitors is allowed for temperatures $T_{max} < 100°C$.
In practice a preheating duration of $t < 5$ min. has been proven to be best.

Single wave soldering
Soldering bath temperature: $T < 260°C$
Immersion time: $t < 5$ sec

Double wave soldering
Soldering bath temperature: $T < 260°C$
Immersion time: $2 \times t < 3$ sec

Due to different soldering processes and heat requirements the graphs are to be regarded as a recommendation only.

Wave soldering



Typical temperature/time graph for double wave soldering

WIMA Quality and Environmental Philosophy

ISO 9001:2000 Certification

ISO 9001:2000 is an international basic standard of quality assurance systems for all branches of industry. The approval according to ISO 9001:2000 of our factories by the VDE inspectorate certifies that organisation, equipment and monitoring of quality assurance in our factories correspond to internationally recognized standards.

WIMA WPCS

The WIMA Process Control System (WPCS) is a quality surveillance and optimization system developed by WIMA. WPCS is a major part of the quality-oriented WIMA production. Points of application of WPCS during production process:

- **incoming material inspection**
- **metallization**
- **film inspection**
- **schoopage**
- **pre-healing**
- **lead attachment**
- **cast resin preparation/ encapsulation**
- **100% final inspection**
- **AQL check**

WIMA Environmental Policy

All WIMA capacitors, irrespective of whether through-hole devices or SMD, are made of environmentally friendly materials. Neither during manufacture nor in the product itself any toxic substances are used, e.g.

- **Lead**
- **PCB**
- **CFC**
- **Hydrocarbon chloride**
- **Chromium 6+**
- **PBB/PBDE**
- **Arsenic**
- **Cadmium**
- **Mercury**
- **etc.**

We merely use pure, recyclable materials for packing our components, such as:

- **carton**
- **cardboard**
- **adhesive tape made of paper**
- **polystyrene**

We almost completely refrain from using packing materials such as:

- **foamed polystyrene (Styropor®)**
- **adhesive tapes made of plastic**
- **metal clips**

RoHS Compliance

According to the RoHS Directive 2002/95/EC certain hazardous substances like e.g. lead, cadmium, mercury must not be used any longer in electronic equipment as of July 1st, 2006. For the sake of the environment WIMA has refraind from using such substances since years already.

Tape for lead-free WIMA capacitors

DIN EN ISO 14001:2005

WIMA's environmental management has been established in accordance with the guidelines of DIN EN ISO 14001:2005. The certification has been granted in June 2006.

Typical Dimensions for Taping Configuration

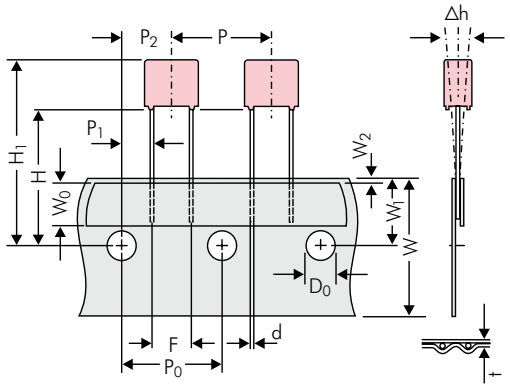


Diagram 1:
PCM 2.5/5/7.5mm

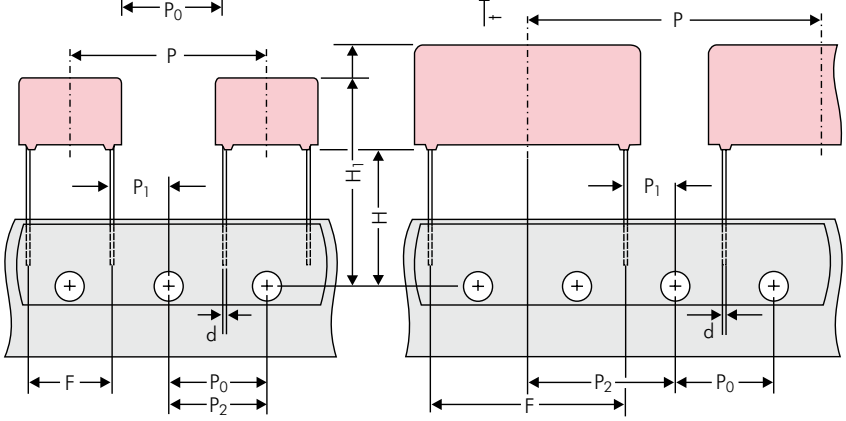


Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5*mm
*PCM 27.5 taping possible with two feed holes between components

Designation	Symbol	Dimensions for Radial Taping						
		PCM 2.5 taping	**PCM 5 taping**	**PCM 7.5 taping**	**PCM 10 taping***	**PCM 15 taping***	**PCM 22.5 taping**	**PCM 27.5 taping**
Carrier tape width	W	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5
Hold-down tape width	W_0	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape
Hole position	W_1	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5
Hold-down tape position	W_2	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.
Feed hole diameter	D_0	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2
Pitch of component	P	12.7 ±1.0	12.7 ±1.0	12.7 ±1.0	25.4 ±1.0	25.4 ±1.0	38.1 ±1.5	*38.1 ±1.5 or 50.8 ±1.5
Feed hole pitch	P_0	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch
Feed hole centre to lead	P_1	5.1 ±0.5	3.85 ±0.7	2.6 ±0.7	7.7 ±0.7	5.2 ±0.7	7.8 ±0.7	5.3 ±0.7
Hole centre to component centre	P_2	6.35 ±1.3	6.35 ±1.3	6.35 ±1.3	12.7 ±1.3	12.7 ±1.3	19.05 ±1.3	19.05 ±1.3
Feed hole centre to bottom edge of the component	H▲	16.5 ±0.3 18.5 ±0.5	16.5 ±0.3 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5
Feed hole centre to top edge of the component	H_1	$H+H_{component} < H_1$ 32.25 max.	$H+H_{component} < H_1$ 32.25 max.	$H+H_{component} < H_1$ 24.5 to 31.5	$H+H_{component} < H_1$ 25.0 to 31.5	$H+H_{component} < H_1$ 26.0 to 37.0	$H+H_{component} < H_1$ 30.0 to 43.0	$H+H_{component} < H_1$ 35.0 to 45.0
Lead spacing at upper edge of carrier tape	F	2.5 ±0.5	5.0 +0.8 −0.2	7.5 ±0.8	10.0 ±0.8	15 ±0.8	22.5 ±0.8	27.5 ±0.8
Lead diameter	d	0.4 ±0.05	0.5 ±0.05	•0.5 ±0.05 or 0.6 +0.06 −0.05	•0.5 ±0.05 or 0.6 +0.06 −0.05	0.8 +0.08 −0.05	0.8 +0.08 −0.05	0.8 +0.08 −0.05
Component alignment	Δh	± 2.0 max.	± 2.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.
Total tape thickness	t	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2
Package (see also page 122)	▲	ROLL/AMMO		AMMO				
		REEL ø 360 max. ø 30 ±1 B 52 ±2 / 58 ±2 depending on comp. dimensions		REEL ø 360 max. ø 30 ±1 B 52 ±2 / 58 ±2 / 66 ±2 or REEL ø 500 max. ø 25 ±1 B 54 ±2 / 60 ±2 / 68 ±2 depending on PCM and component dimensions				
Unit		see details page 124.						

▲ Please give „H" dimensions and desired packaging type when ordering.

• Diameter of leads see General Data.

* PCM 10 and PCM 15 can be crimped to PCM 7.5.
Position of components according to PCM 7.5 (sketch 1). P_0 = 12.7 or 15.0 is possible

Dims in mm.

Please clarify customer-specific deviations with the manufacturer.